

## C1808C103MFRACTU

Aliases (C1808C103MFRAC7800)

SMD Comm X7R HV, Ceramic, 0.01 uF, 20%, 1,500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1808, 2.9 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	100 mg
Shelf Life	78 Weeks
MSL	1

0.01 uF

Dimensions	
Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
Т	2mm +/-0.15mm
S	2.9mm MIN
В	0.6mm +/-0.35mm

-	4.711111 - 7 0.511111
W	2mm +/-0.2mm
Т	2mm +/-0.15mm
S	2.9mm MIN
В	0.6mm +/-0.35mm
Packaging Specifications	

Packaging

Packaging Quantity

4.7mm +/-0.5mm	Measurement Condition	1 kHz 1.0Vrms
2mm +/-0.2mm	Tolerance	20%
2mm +/-0.15mm	Voltage DC	1500 VDC
2.9mm MIN	Dielectric Withstanding Voltage	1,800 VDC
0.6mm +/-0.35mm	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
	Capacitance Change with	15%, 1kHz 1.0Vrms
T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
1000	Dissipation Factor	2.5%1kHz1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
	Insulation Resistance	100 GOhms

**Specifications** 

Capacitance

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